



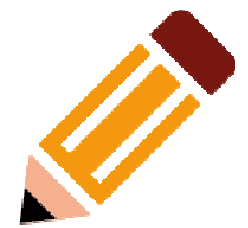
UCLA
Physics & Astronomy

UCLA Dark Matter 2018

SiPM at cryogenic temperature for dark matter

Alessandro Razeto - LNGS

DarkSide-20k



About 14 m² of light sensitive surface
for single photon counting
at LAr temperature
with SiPM

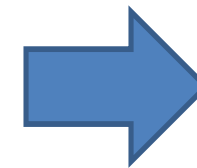
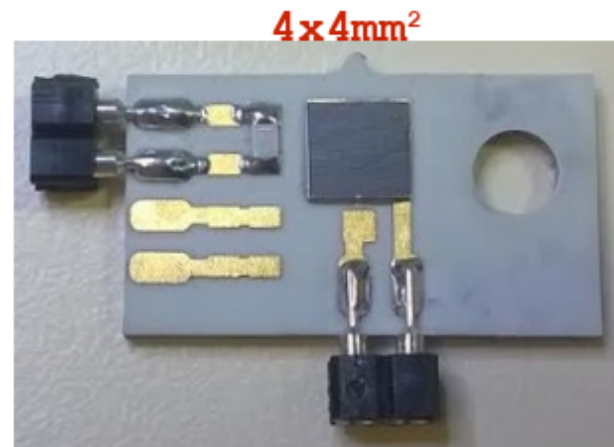
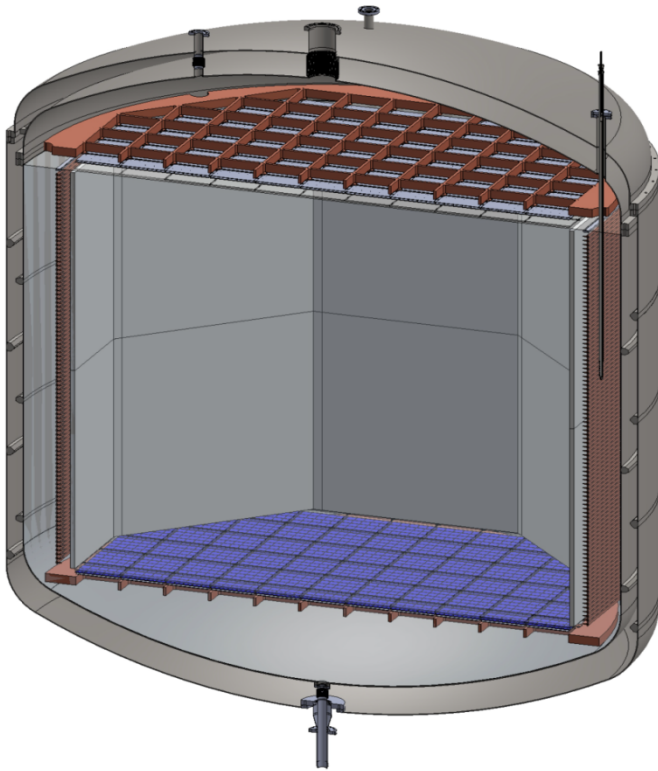
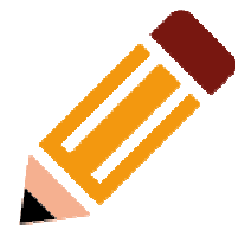
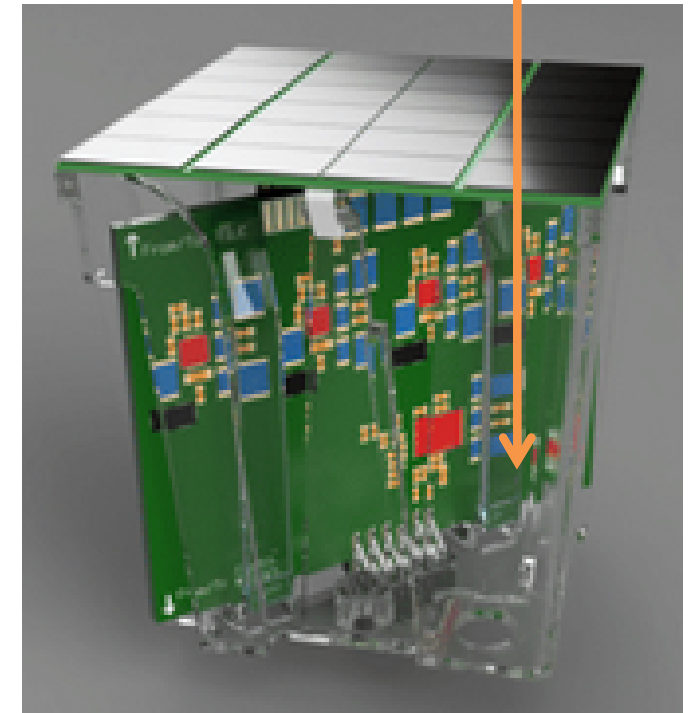
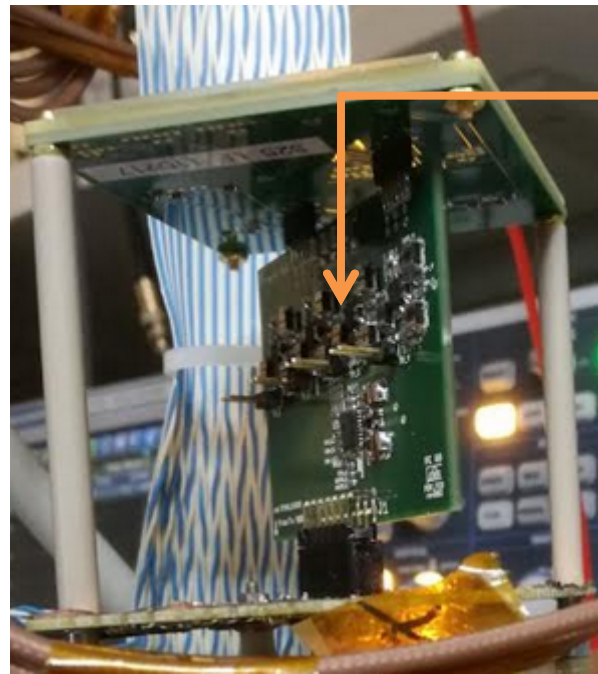
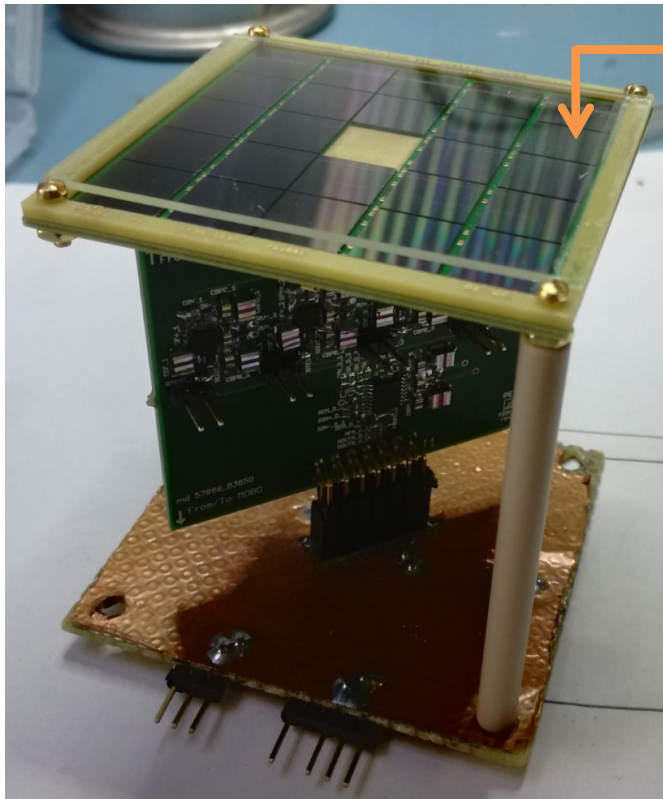


Photo-Detector Module



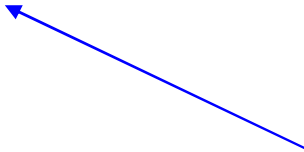
- Silicon-based PMT equivalent
- The basic photo-detector element in DS-20k
 - One read-out analog channel per PDM
 - Aggregating all the SiPM signals
- Integrates the SiPMs (TILE) and the electronics (FEB) in a plastic cage



- Surface: $\sim 50 \times 50 \text{ mm}^2$
 - Contain the number of channels

PDM Requirements

14 m² / 25 cm² ~ 5200 PDM



PDM Requirements

- Surface: $\sim 50 \times 50 \text{ mm}^2$
 - Contain the number of channels
- PDE of a PDM: $\geq 40\%$
 - PDE of a SiPM: $\geq 45\%$
 - Increased Light Yield

PDE = Photon Detection efficiency

Considering a dead space
between SiPMs of 0.5 mm

$\sim 98\%$ packing (form factor)
vs $< 90\%$ for circular PMTs
 $\sim 90\%$ of surface is active
vs 70% of PMT R11065

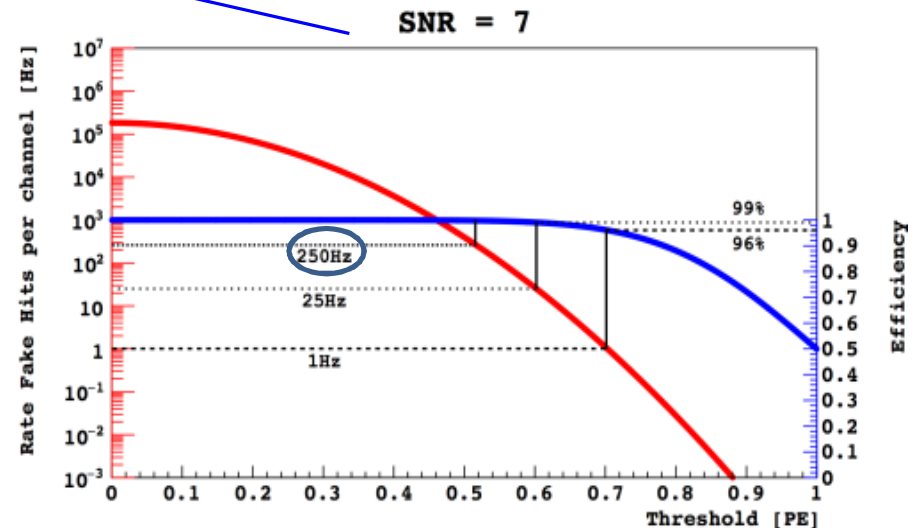
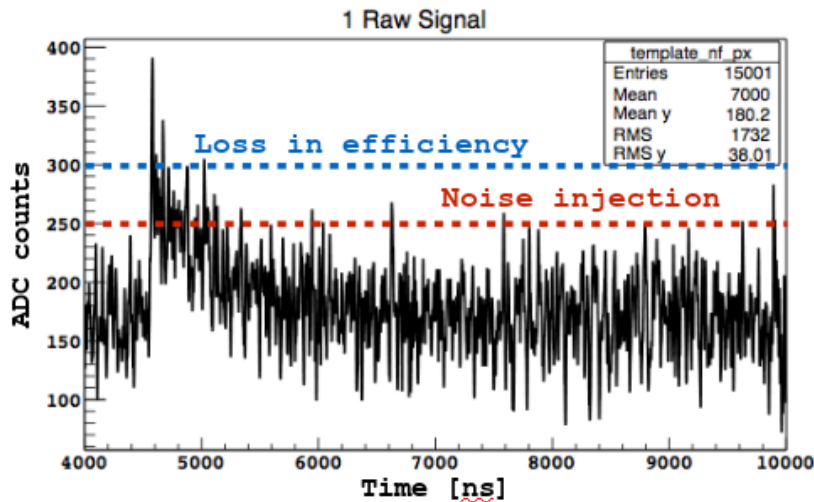
R11065 effective Q.E. $\sim 22\%$

PDM Requirements

DCR = Dark Count Rate

- Surface: $\sim 50 \times 50 \text{ mm}^2$
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 - PDE of a SiPM: $\geq 45\%$
 - Increased Light Yield
- Noise: $\text{DCR} + \text{Electronic noise hits} < 0.1 \text{ cps/mm}^2$
 - Keep PSD effective
 - Avoid fake triggers
 - $\text{SNR} > 7$

$14 \text{ m}^2 \text{ \& } O(10 \mu\text{s}) \rightarrow \sim 15 \text{ pe}$



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- TCN $< 60\%$
 - Energy reconstruction of S2

TCN = Total Correlated noise
Afterpulse + Cross talk

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- Time Resolution: $O(10\text{ns})$
 - Keep PSD effective

Time jitter is crucial to Pulse Shape Discrimination.


High jitter allows leakage of prompt photons outside of the time window.

The effect is dramatic at 40 ns, while still acceptable up to 15 ns.


PDM Requirements

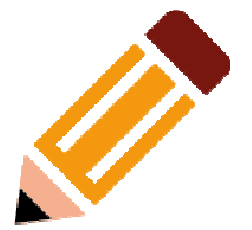
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 - Time Resolution: $O(10\text{ns})$
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 - Energy reconstruction of S2
 - Power consumption: $< 250 \text{ mW}$
 - Avoid LAr bubbling and overload on cryogenic systems
- 

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 - Power consumption: $< 250 \text{ mW}$
 - Avoid LAr bubbling and overload on cryogenic systems
 - Radiopurity: fraction of mBq ($^{238}\text{U} + ^{232}\text{Th}$)
- 



SiPMs



FBK NUV-HD SiPMs

Strong collaboration with FBK

- Several technologies and their variants were studied

The NUV-HD technology was selected

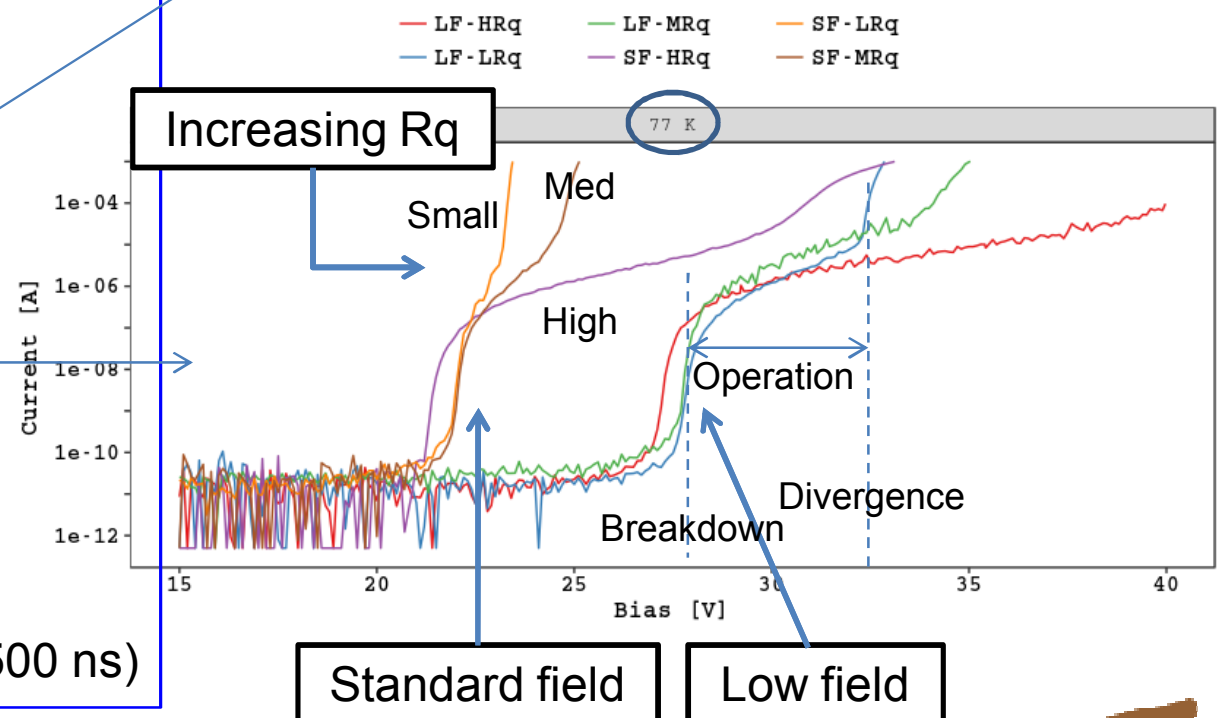
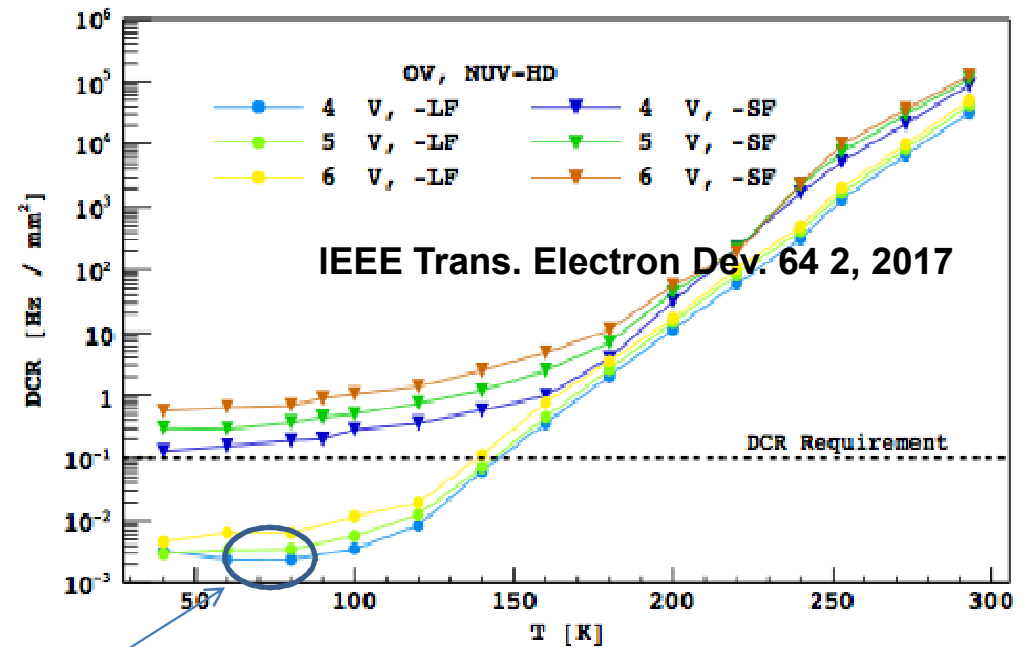
- Peak sensitivity at ~ 420 nm
- High density SPAD with high PDE

Low field variant:

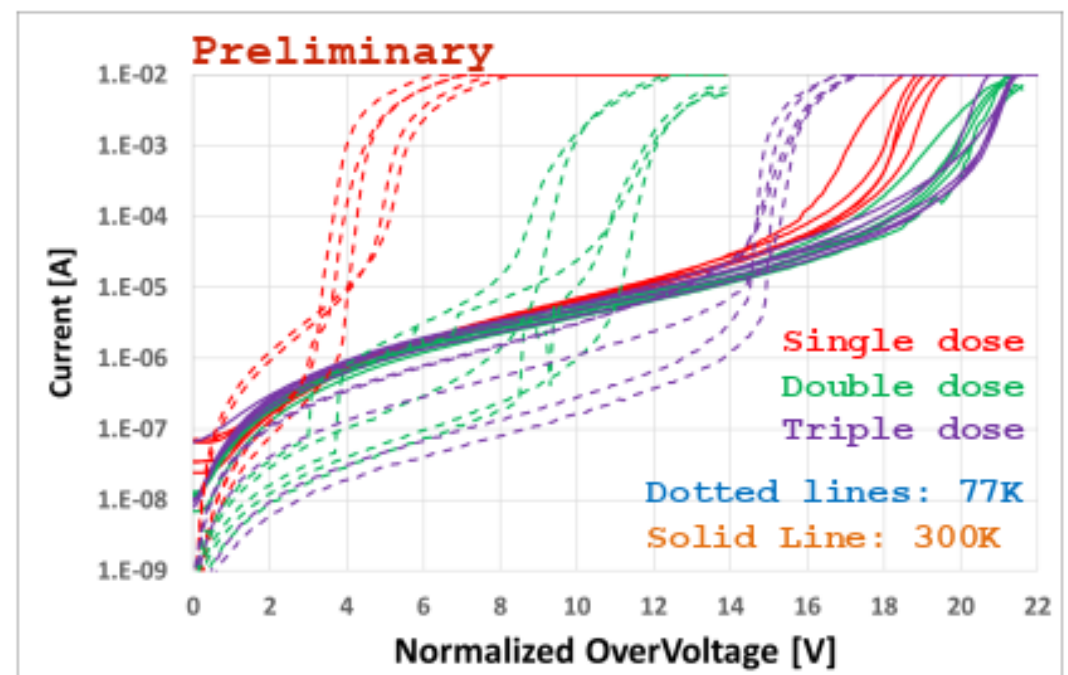
- DCR ~ 5 mcps/mm² at 80 K
- Higher over-voltage operation

The NUV-HD technology requires high quenching resistor (R_q) at 80 K

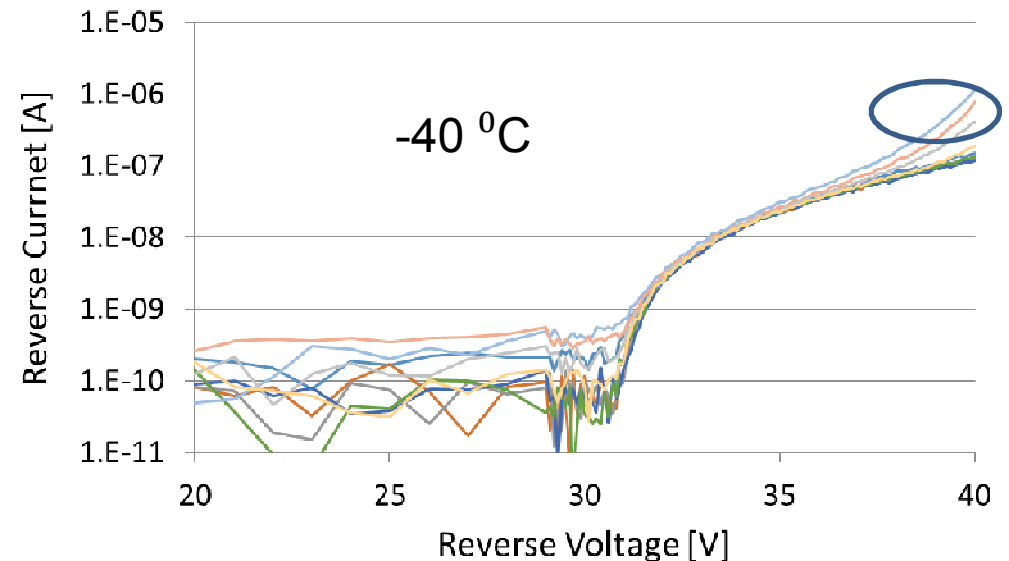
- Resulting in long recharge times – O(500 ns)



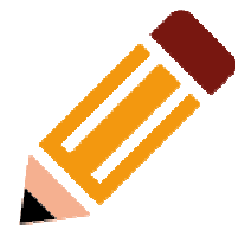
SiPM triple doping



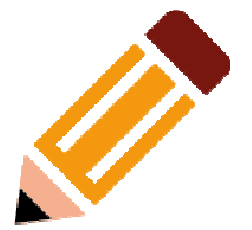
- FBK developed a NUV-HD variant for extended gain at cryogenic temperature
 - It is based on a different (higher) doping
 - This variant allow operation of NUV-HD at 14 Volt over-voltage
 - The DCR at 80K is compatible to standard NUV-HD
- An R&D run was produced at FBK
 - It is based on NUV-HD-LF with 3x doping
 - We received the run few weeks ago
 - Initial tests show a low yield at -40°C
 - To be verified at 80 K



SiPM: future developments



- FBK:
 - A set of 3 scientific/R&D runs are programmed for 2018
 - The goal is to fine tune the parameters to best match SiPM with FEB
 - Produce 50 PDM
- LFoundry:
 - The contract INFN-LFoundry will be soon operative
 - The FBK technology will be transferred to LFoundry
 - Will be in charge of the mass production of the SiPM
- Through-silicon via (TSV):
 - TSV technology will allow us to reach the high fill factor required
 - Simplify the packaging and increase the robustness of the PDMs
 - By getting rid of the wire bonding
 - A R&D program between SMIC/LFoundry and DarkSide is in definition

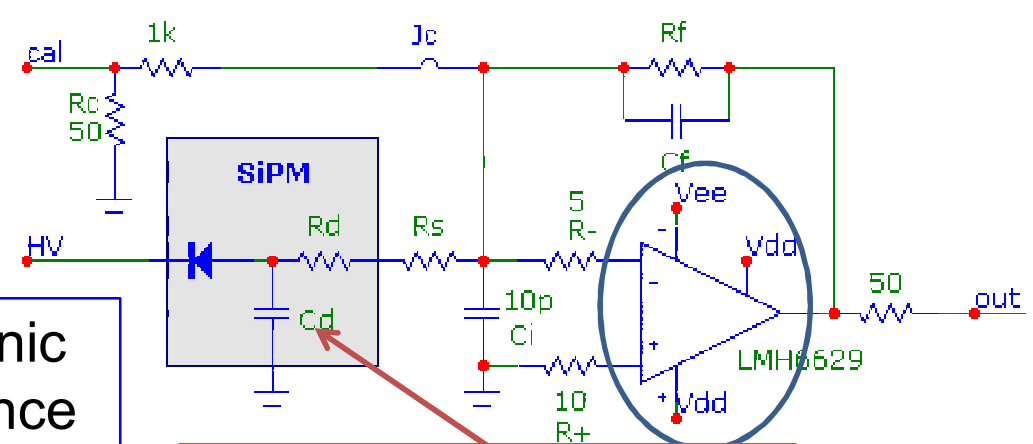


Electronics

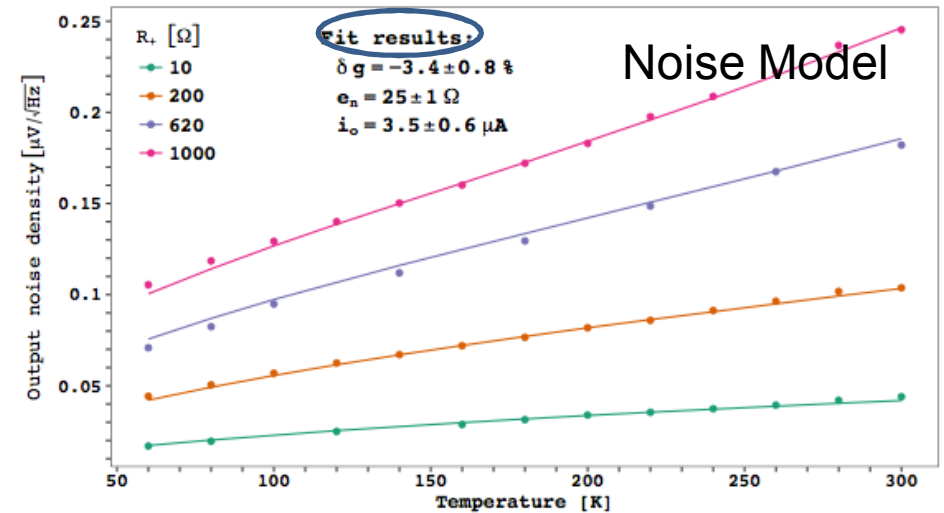
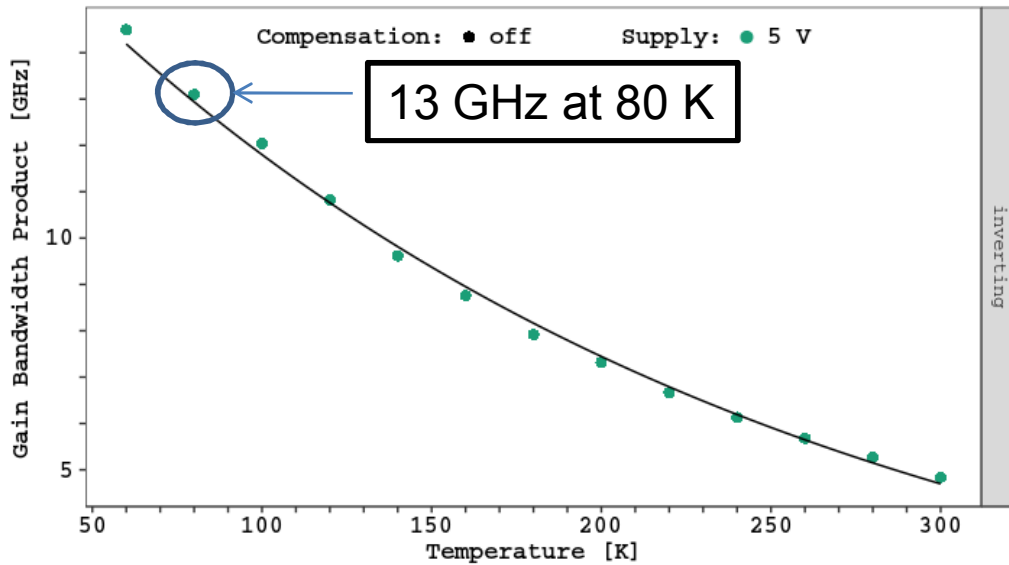


Very High Speed and Low Noise

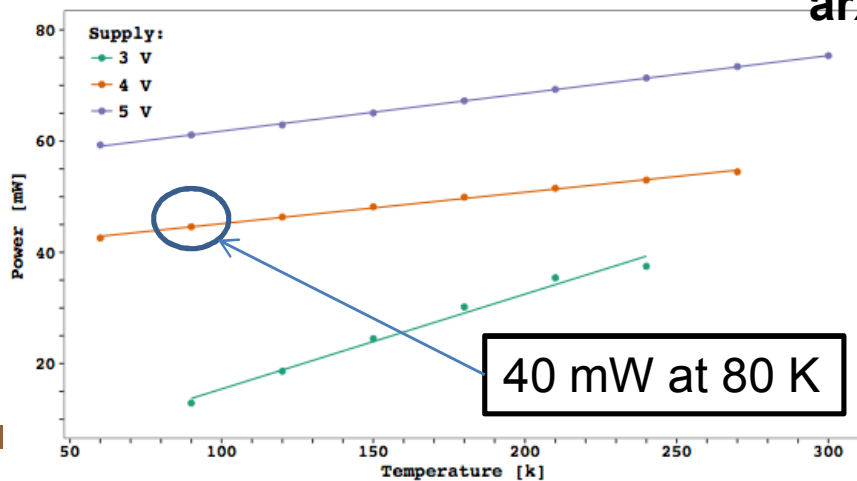
Op-Amp based TransImpedance cryogenic amplifier for low noise and high capacitance



@ 80K: $R_d \sim 60 \Omega$ $C_d \sim 6 \text{ nF}$



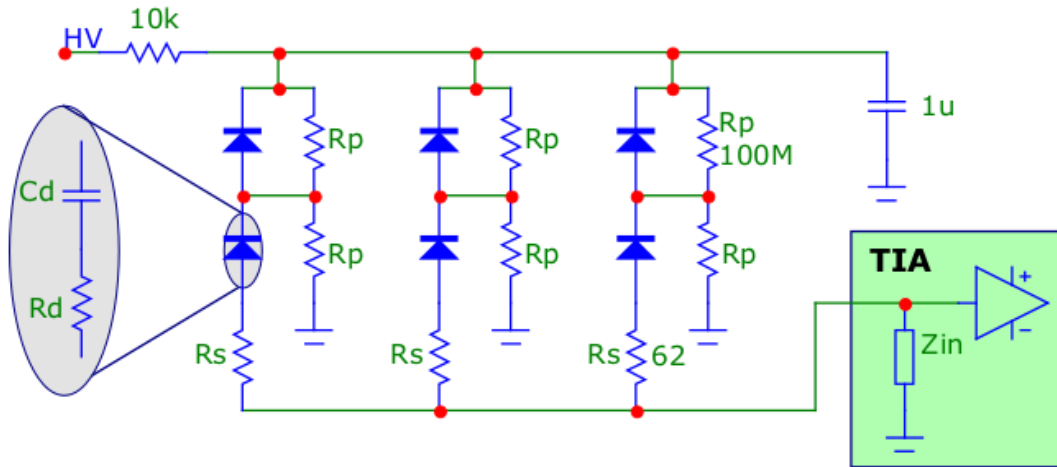
arXiv:1706.04213



Noise	300K	80K
e_n [nV/√Hz]	0.64	0.33
i_n [pA/√Hz]	2.6	1.1

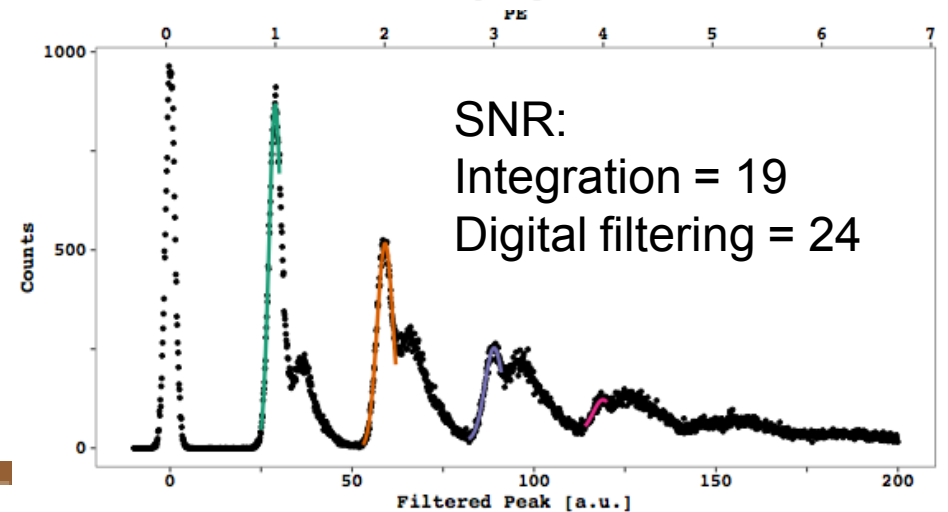
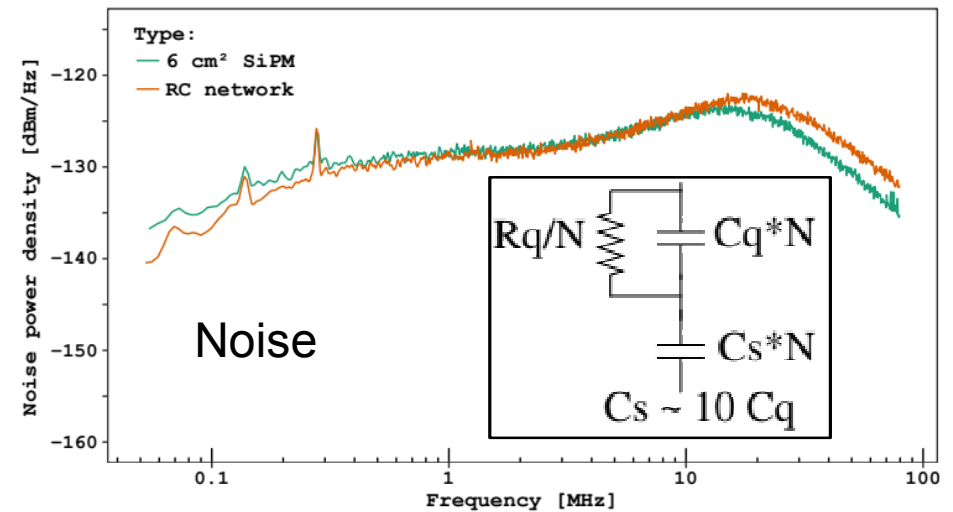
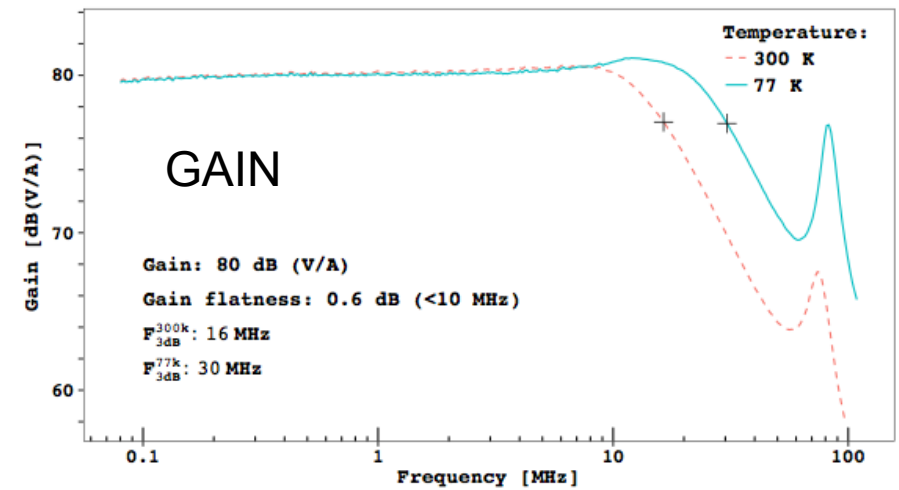
high speed required to maintain the fast peak

6 cm² read-out



2s3p configuration optimal:

- BW sufficient to preserve the pulse fast peak
- The amplitude of the signal is halved
- The noise gain is reduced by a factor ~ 3
- The output noise depends on the SiPM model
 - We were able to produce a SiPM equivalent with 2 capacitors and 1 resistor



24 cm²

The signal from the 4 x 6 cm² quadrants is summed with an active adder

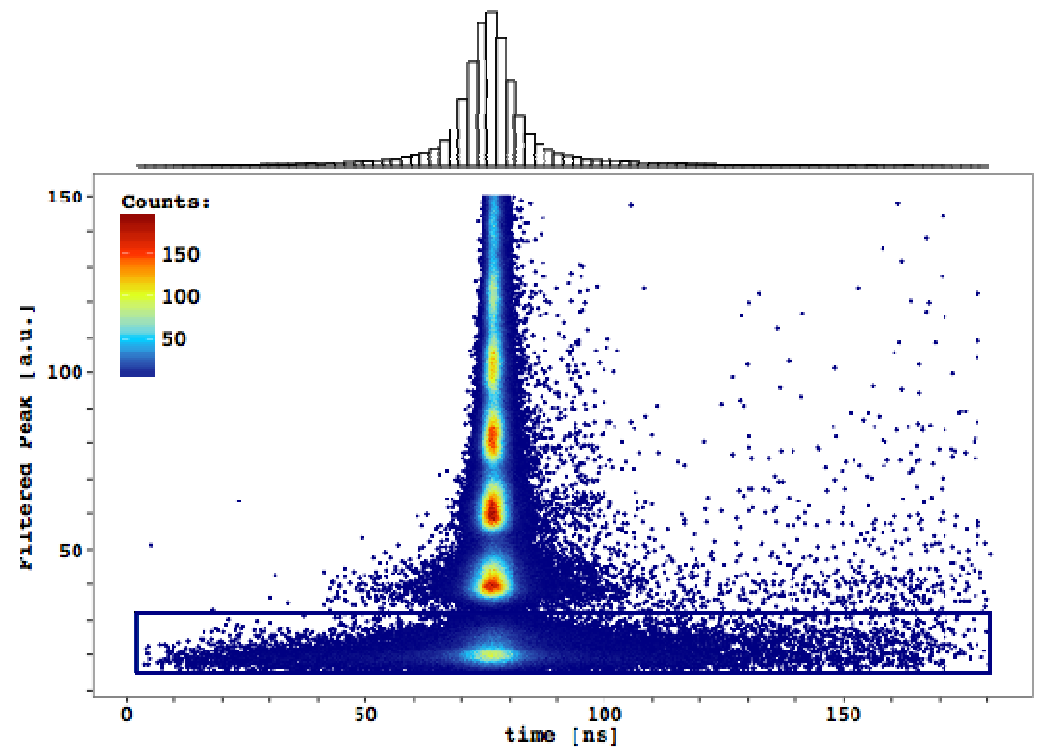
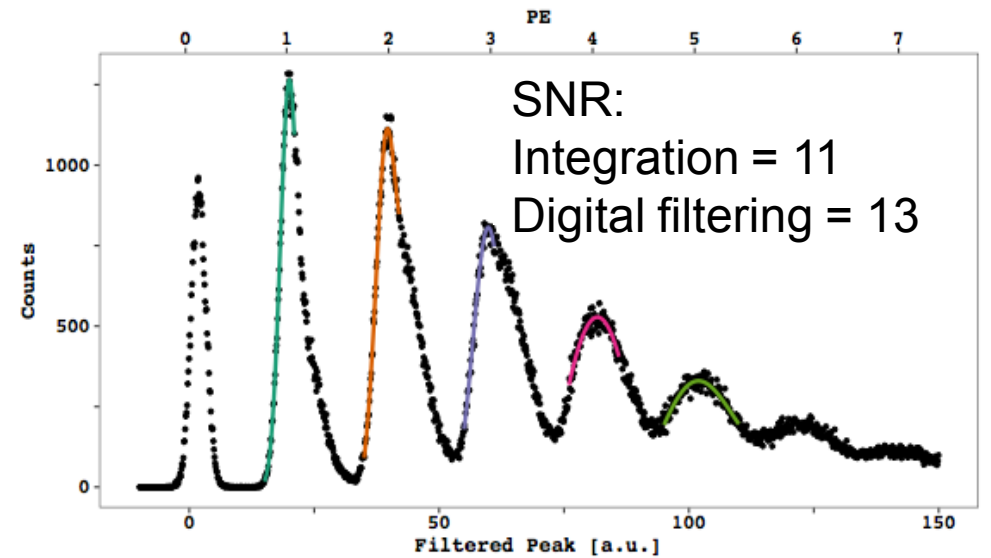
Full 24 cm² tile with NUV-HD-LF at LN2 5 V_{OV}:

- $\sigma_{1PE} = 9\% \mu_{1PE}$
- SNR = 13
- 1PE Time resolution: 16ns

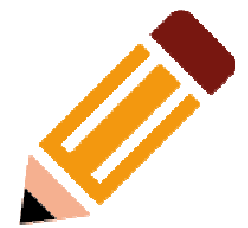
Total power dissipation ~ 170 mW

Dynamic range > 100 PE

- Rail to rail adder and differential driver

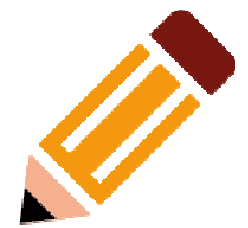


FEB future

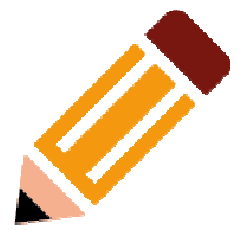


- Component screening
 - All major components have been screened
 - Total $\sim 60 \mu\text{Bq/PDM}$ (ICPMS for ^{238}U and ^{232}Th)
 - Definition of PCB substrate and connectors still ongoing
 - Signal extraction on optical fibers
 - Avoiding the activity from signal cables
- The limiting factor on the SNR of the 24 cm^2 is the recharge constant of SiPMs ($\sim 500 \text{ ns}$)
 - Considering a fast recharge, $O(20 \text{ ns})$, the SNR would increase by a factor ~ 5
 - This would give a SNR ~ 20 for the unfiltered signal on 24 cm^2
 - A measurement is ongoing at LNGS with Hamamatsu SiPMs

Conclusions



- The R&D on SiPM and front-end electronics is almost over
- We reached all the design goal for the project
 - 24 cm² SiPM based aggregate detector with SNR = 13
 - Large dynamic range
 - Low power dissipation
 - Radio-pure components
- Still some issues to be solved
 - Low CTE and radio-pure substrate
 - Radio-pure connectors
 - Finalize the SiPM parameters
- Develop and test TSV
- The next step is large scale optimization
 - And the mass production

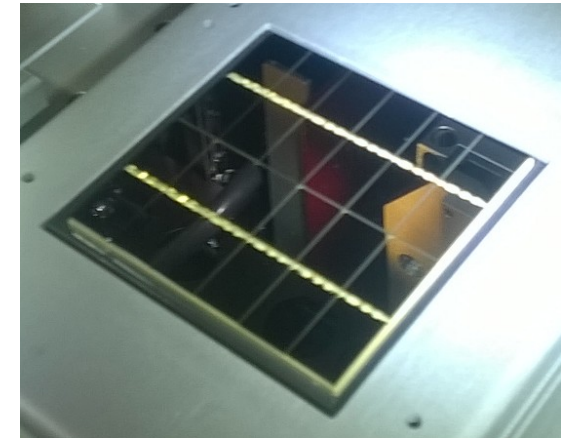
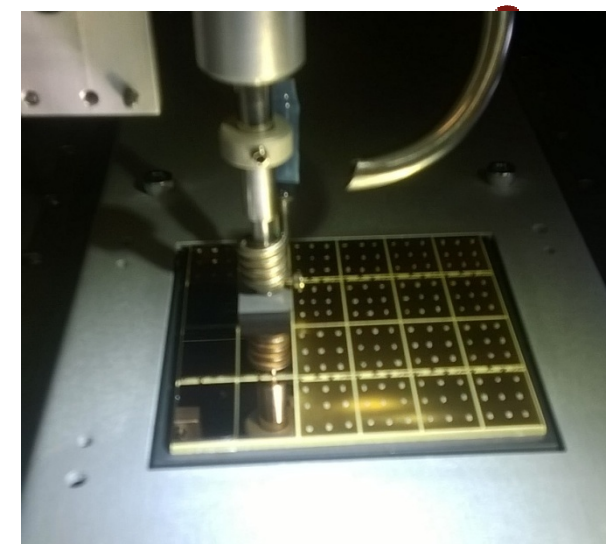


Thank you

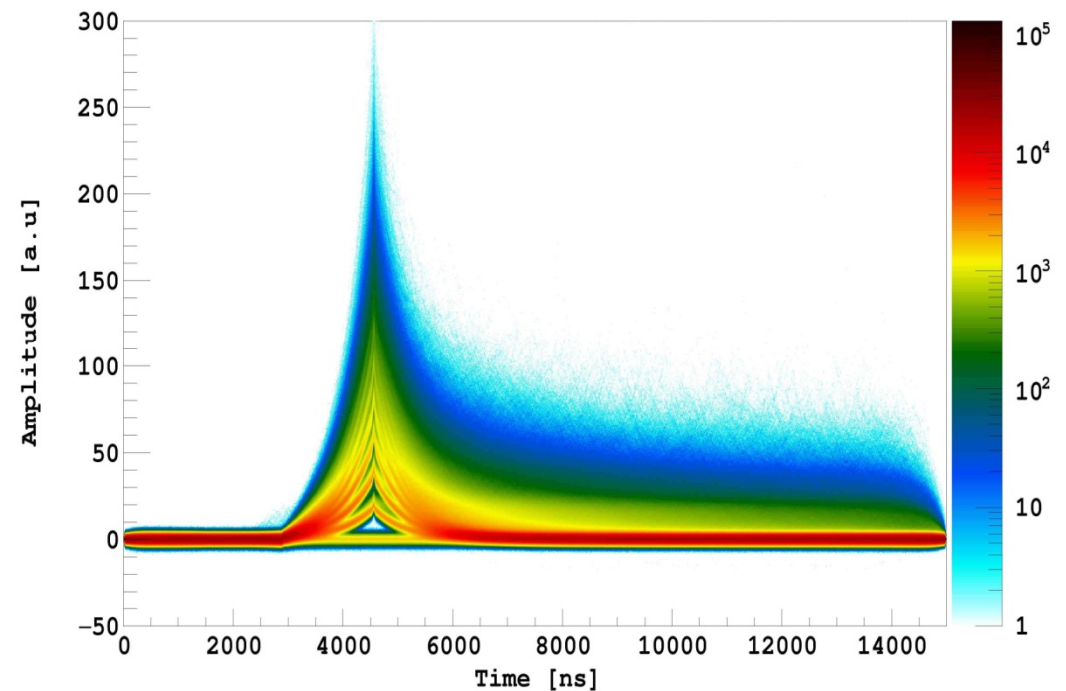
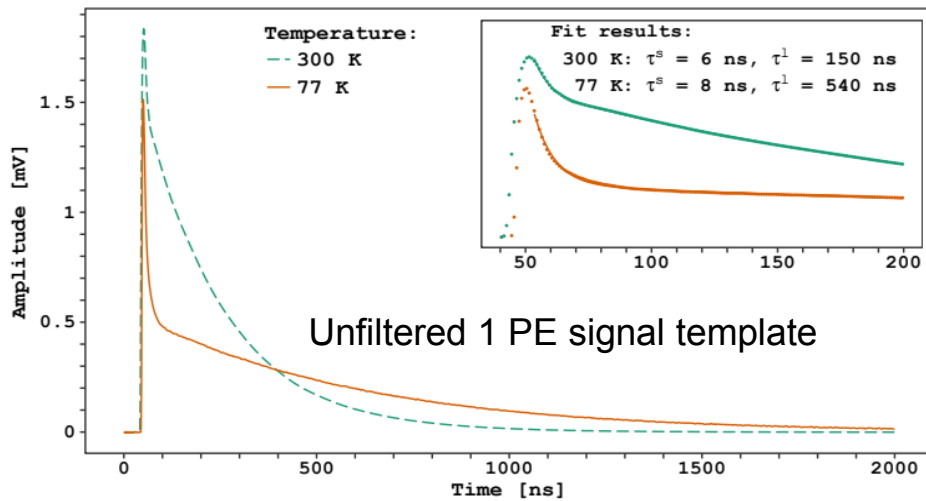


Packaging facility at LNGS

- A packaging facility (NOA) has been funded at LNGS
- The project includes
 - A cryogenic wafer probe
 - A fully automated die bonder for the SiPMs
 - A fully automated wire bonder
 - A radio-pure SMT reflow process for the FEBs
 - A warm/cryogenic test station for SiPMs
- The facility is designed to mount all the PDMs in 2 years



Digital filtering

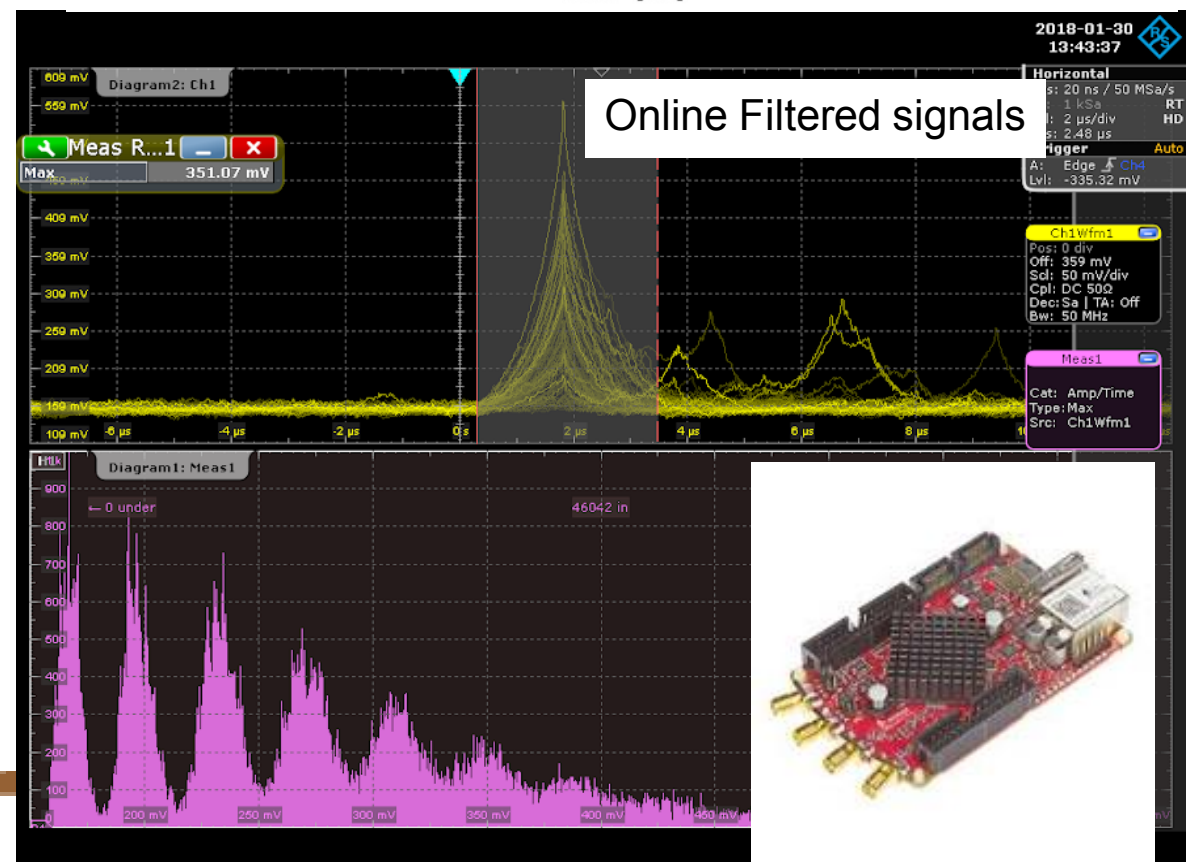


Matched filter the optimal linear filter to extract a signal of know shape in the presence of additive stochastic noise.

The filtered signal is obtained by cross-convoluting the raw waveform for the signal template

The output is symmetric around the peak, giving a better identification of the timing.

We successfully tested an online FPGA based implementation



PDE

